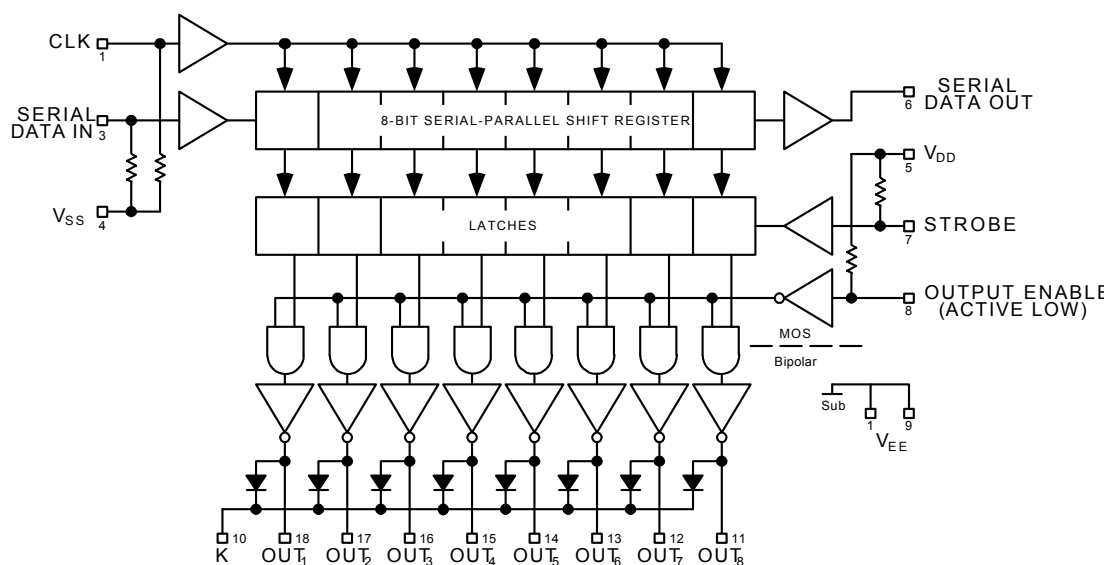
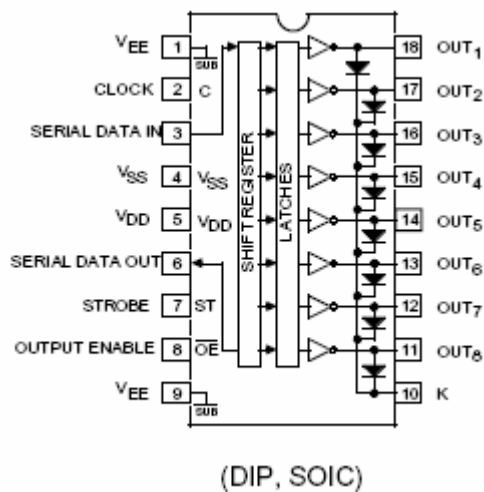
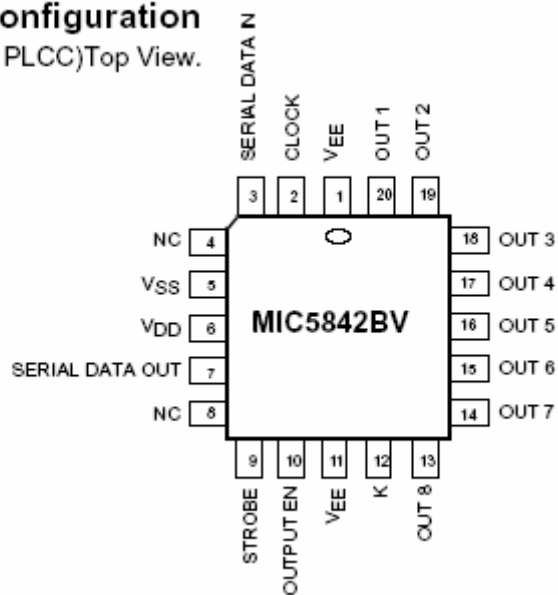


Functional Diagram



Pin Configuration

(20-Pin PLCC) Top View.



At 25°C Free-Air Temperature and V_{SS}	0V
Output Voltage, V_{CE} (MIC5841)	50V
(MIC5842)	80V
Output Voltage, $V_{CE(SUS)}$ (MIC5841) ⁽¹⁾	35V
(MIC5842)	50V
Logic Supply Voltage, V_{DD}	15V
V_{DD} with Reference to V_{FF}	25V

Emitter Supply Voltage, V_{EE}	-20V
Input Voltage Range, V_{IN}	-0.3V to $V_{DD} + 0.3V$
Continuous Output Current, I_{OUT}	500mA
Package Power Dissipation, $P_D^{(2)}$	1.82W
Operating Temperature Range, T_A	-55°C to +85°C
Storage Temperature Range, T_S	-65°C to +150°C

At $T_A = 25^\circ\text{C}$ $V_{DD} = 5\text{V}$, $V_{SS} = V_{EE} = 0\text{V}$ (unless otherwise noted)

Characteristic	Symbol	Applicable Devices	Test Conditions	Limits		
				Min	Max	Unit
Output Leakage Current	I _{CEX}	MIC5841	V _{OUT} = 50V		50	μA
			V _{OUT} = 50V, T _A = +70°C		100	
		MIC5842	V _{OUT} = 80V		50	
			V _{OUT} = 80V, T _A = +70°C		100	
Collector-Emitter Saturation Voltage	V _{CE(SAT)}	Both	I _{OUT} = 100mA		1.1	V
			I _{OUT} = 200mA		1.3	
			I _{OUT} = 350mA, V _{DD} = 7.0V		1.6	
Collector-Emitter Saturation Voltage	V _{CE(SUS)} ⁽⁵⁾	MIC5841	I _{OUT} = 350mA, L = 2mH	35		V
		MIC5842	I _{OUT} = 350mA, L = 2mH	50		
Input Voltage	V _{IN(0)}	Both			0.8	V
	V _{IN(1)}	Both	V _{DD} = 12V	10.5		
			V _{DD} = 10V	8.5		
			V _{DD} = 5.0V(4)	3.5		
Input Resistance	R _{IN}	Both	V _{DD} = 12V	50		kΩ
			V _{DD} = 10V	50		
			V _{DD} = 5.0V	50		
Supply Current	I _{DD(ON)}	Both	All Drivers ON, V _{DD} = 12V		16	1.6
			All Drivers ON, V _{DD} = 10V		14	
			All Drivers ON, V _{DD} = 5.0V		8.0	
	I _{DD(OFF)}	Both	All Drivers OFF, V _{DD} = 12V		2.9	
			All Drivers OFF, V _{DD} = 10V		2.5	
			All Drivers OFF, V _{DD} = 5.0V		1.6	
Clamp Diode Leakage Current	I _R	MIC5841	V _R = 50V		50	μA
		MIC5842	V _R = 80V		50	
Clamp Diode Forward Voltage	V _F	Both	I _F = 350mA		2.0	V

Electrical Characteristics

At $T_A = -55^\circ\text{C}$ $V_{DD} = 5\text{V}$, $V_{SS} = V_{EE} = 0\text{V}$ (unless otherwise noted)

Characteristic	Symbol	Test Conditions	Limits		
			Min	Max	Unit
Output Leakage Current	I_{CEX}	$V_{OUT} = 80\text{V}$		50	μA
Collector-Emitter Saturation Voltage	$V_{CE(SAT)}$	$I_{OUT} = 100\text{mA}$		1.3	V
		$I_{OUT} = 200\text{mA}$		1.5	
		$I_{OUT} = 350\text{mA}$, $V_{DD} = 7.0\text{V}$		1.8	
Input Voltage	$V_{IN(0)}$			0.8	V
	$V_{IN(1)}$	$V_{DD} = 12\text{V}$	10.5		
		$V_{DD} = 5.0\text{V}$	3.5		
Input Resistance	R_{IN}	$V_{DD} = 12\text{V}$	35		$\text{k}\Omega$
		$V_{DD} = 10\text{V}$	35		
		$V_{DD} = 5.0\text{V}$	35		
Supply Current	$I_{DD(ON)}$	All Drivers ON, $V_{DD} = 12\text{V}$		16	mA
		All Drivers ON, $V_{DD} = 10\text{V}$		14	
		All Drivers ON, $V_{DD} = 5.0\text{V}$		10	
	$I_{DD(OFF)}$	All Drivers OFF, $V_{DD} = 12\text{V}$		3.5	
		All Drivers OFF, $V_{DD} = 5.0\text{V}$		2.0	

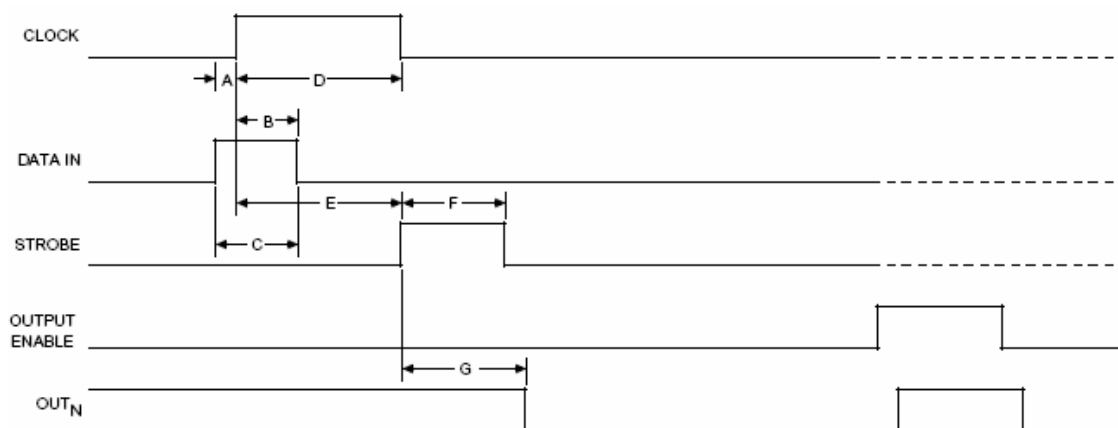
Electrical Characteristics

At $T_A = +125^\circ\text{C}$ $V_{DD} = 5\text{V}$, $V_{SS} = V_{EE} = 0\text{V}$ (unless otherwise noted)

Characteristic	Symbol	Test Conditions	Limits		
			Min	Max	Unit
Output Leakage Current	I_{CEX}	$V_{OUT} = 80\text{V}$		500	μA
Collector-Emitter Saturation Voltage	$V_{CE(SAT)}$	$I_{OUT} = 100\text{mA}$		1.3	V
		$I_{OUT} = 200\text{mA}$		1.5	
		$I_{OUT} = 350\text{mA}$, $V_{DD} = 7.0\text{V}$		1.8	
Input Voltage	$V_{IN(0)}$			0.8	V
	$V_{IN(1)}$	$V_{DD} = 12\text{V}$	10.5		
		$V_{DD} = 5.0\text{V}$	3.5		
Input Resistance	R_{IN}	$V_{DD} = 12\text{V}$	50		$\text{k}\Omega$
		$V_{DD} = 10\text{V}$	50		
		$V_{DD} = 5.0\text{V}$	50		
Supply Current	$I_{DD(ON)}$	All Drivers ON, $V_{DD} = 12\text{V}$		16	mA
		All Drivers ON, $V_{DD} = 10\text{V}$		14	
		All Drivers ON, $V_{DD} = 5.0\text{V}$		8	
	$I_{DD(OFF)}$	All Drivers OFF, $V_{DD} = 12\text{V}$		2.9	
		All Drivers OFF, $V_{DD} = 5.0\text{V}$		2.1.6	
Clamp Diode Leakage Current	I_R	MIC5841A $V_R = 50\text{V}$		1.6	μA
		MIC5842A $V_R = 80\text{V}$		100	

Notes:

1. For Inductive load applications.
2. Derate at the rate of $18.2\text{mW}/^\circ\text{C}$ above $T_A = 25^\circ\text{C}$ (Plastic DIP)
3. CMOS devices have input-static protection but are susceptible to damage when exposed to extremely high static electrical charges.
4. Operation of these devices with standard TTL may require the use of appropriate pull-up resistors to insure an input logic HIGH.
5. Not 100% tested. Guaranteed by design.



Timing Conditions

(TA = 25°C Logic Levels are V_{DD} and V_{SS})

V_{DD} = 5V

A. Minimum Data Active Time Before Clock Pulse (Data Set-Up Time).....	75 ns
B. Minimum Data Active Time After Clock Pulse (Data Hold Time)	75 ns
C. Minimum Data Pulse Width	150 ns
D. Minimum Clock Pulse Width.....	150 ns
E. Minimum Time Between Clock Activation and Strobe	300 ns
F. Minimum Strobe Pulse Width.....	100 ns
G. Typical Time Between Strobe Activation and Output Transition.....	500 ns

SERIAL DATA present at the input is transferred to the shift register on the logic “0” to logic “1” transition of the CLOCK input pulse. On succeeding CLOCK pulses, the registers shift data information towards the SERIAL DATA OUTPUT. The SERIAL DATA must appear at the input prior to the rising edge of the CLOCK input waveform.

Information present at any register is transferred to its respective latch when the STROBE is high (serial-to-parallel conversion). The latches will continue to accept new data as long as the STROBE is held high. Applications where the latches are bypassed (STROBE tied high) will require that the ENABLE input be high during serial data entry.

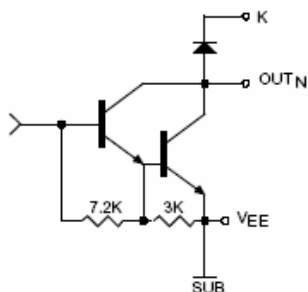
When the ENABLE input is high, all of the output buffers are disabled (OFF) without affecting information stored in the latches or shift register. With the ENABLE input low, the outputs are controlled by the state of the latches.

MIC5840 Family Truth Table

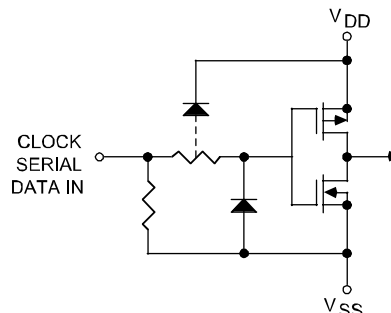
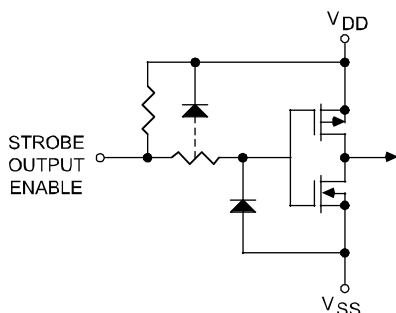
Serial Data Input	Clock Input	Shift Register Contents					Serial Data Output	Strobe Input	Latch Contents					Output Enable	Output Contents				
		I ₁	I ₂	I ₃	...	I ₈			I ₁	I ₂	I ₃	...	I ₈		O ₁	O ₂	O ₃	...	O ₈
H		H	R1	R2	...	R7	R7												
L		L	R1	R2	...	R7	R7												
X		R1	R2	R3	...	R8	R8												
		X	X	X	...	X	X	L	R1	R2	R3	...	R8	L	P1	P2	P3	...	P8
		P1	P2	P3	...	P8	P8	H	P1	P2	P3	...	P8		H	H	H	...	H
									X	X	X	...	X		H	H	H	...	H

L = Low Logic Level
H = High Logic Level
X = Irrelevant
P = Present State
R = Previous State

Typical Output Driver



Typical Input Circuits



Maximum Allowable Duty Cycle (Plastic DIP)

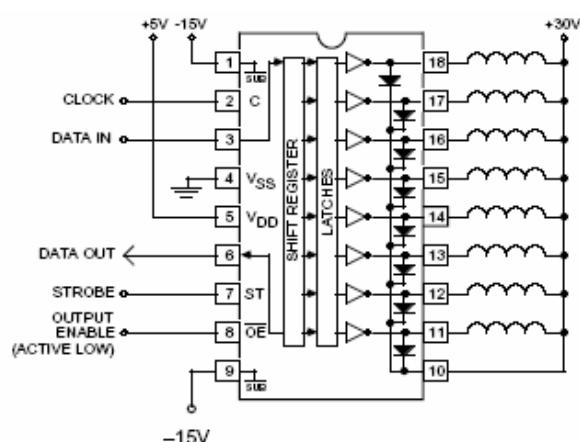
$V_{DD} = 5.0V$

Number of Outputs ON ($I_{OUT} = 200mA$ $V_{DD} = 5.0V$)	Max. Allowable Duty Cycle at Ambient Temperature of				
	25°C	40°C	50°C	60°C	70°C
8	85%	72%	64%	55%	46%
7	97%	82%	73%	63%	53%
6	100%	96%	85%	73%	62%
5	100%	100%	100%	88%	75%
4	100%	100%	100%	100%	93%
3	100%	100%	100%	100%	100%
2	100%	100%	100%	100%	100%
1	100%	100%	100%	100%	100%

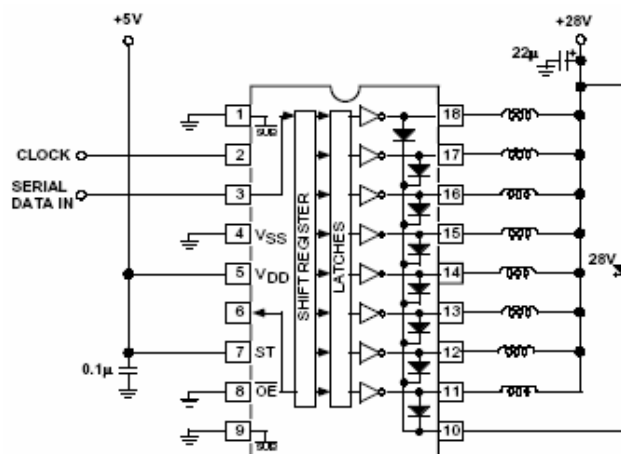
$V_{DD} = 12V$

Number of Outputs ON ($I_{OUT} = 200mA$ $V_{DD} = 12V$)	Max. Allowable Duty Cycle at Ambient Temperature of				
	25°C	40°C	50°C	60°C	70°C
8	80%	68%	60%	52%	44%
7	91%	77%	68%	59%	50%
6	100%	90%	79%	69%	58%
5	100%	100%	95%	82%	69%
4	100%	100%	100%	100%	86%
3	100%	100%	100%	100%	100%
2	100%	100%	100%	100%	100%
1	100%	100%	100%	100%	100%

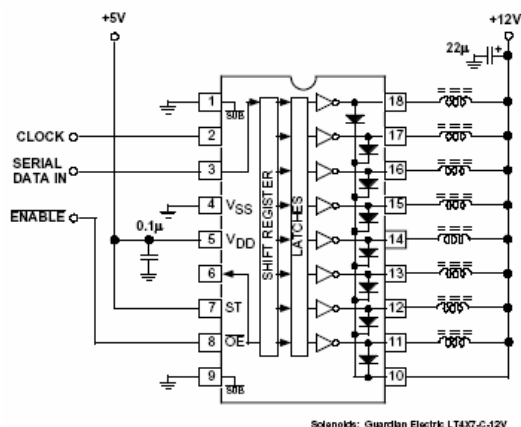
Typical Applications



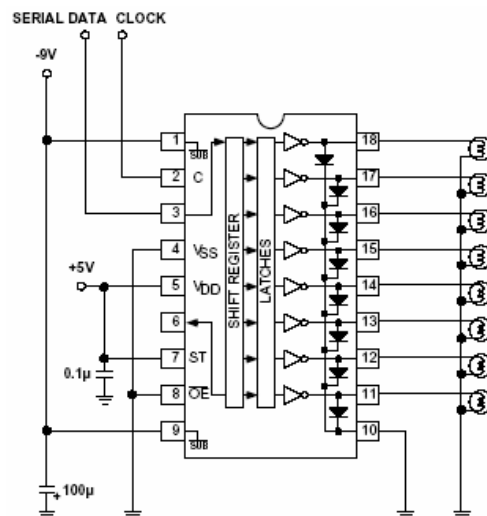
Relay/Solenoid Driver MIC5842



MIC5841 Hammer Driver



MIC5841 Solenoid Driver with Output Enable



MIC5841 Level Shifting Lamp Driver with Darlington Emitters Tied to a Negative Supply

The diagram shows a 3-bit shift register with three latches (D1, D2, D3) and a truth table. The shift register has pins 1 (SUB), 2 (C), 3 (SUB), 4 (VSS), 5 (VDD), 6 (SUB), 7 (ST), 8 (OE), and 9 (SUB). The latches are labeled D1, D2, and D3. The truth table is as follows:

	D1 (Latch 1)	D2 (Latch 5)	D3 (Latch 8)
Receive	OFF	ACTIVE	OFF
Transmit	ACTIVE	OFF	ACTIVE

TEL +1 (408) 944-0800 FAX +1 (408) 474-1000 WEB <http://www.micrel.com>

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